



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Siamak Fazelpour

Serial No.: 10/025,438

Filed: December 19, 2001

For: **Method For Integrating Passives
On-Die Utilizing Under Bump Metal
And Related Structure**

Art Unit: 2812

Examiner: Nguyen, Ha T.

#4/Eat
(ma)
Amelt A w/ Hango
Amelt
2/26/03

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FEB 13 2003
TECHNOLOGY CENTER 2800

AMENDMENT AND RESPONSE TO OFFICE ACTION

Honorable Commissioner of
Patents and Trademarks
Washington, D.C. 20231

Dear Sir/Madam:

This is in response to the Office Action dated October 4, 2002 in the above-referenced patent application. Please enter and consider the following amendments and remarks.

02/12/2003 DTESSEM1 00000046 10025438

01 FC:1251

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